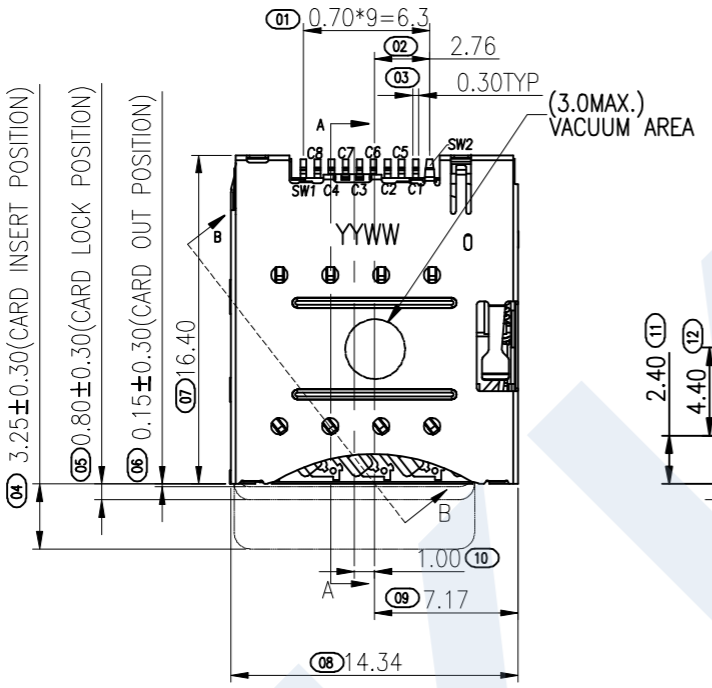
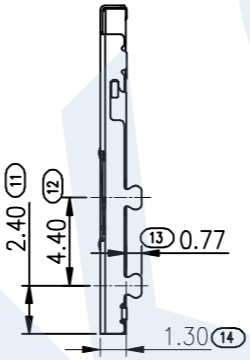
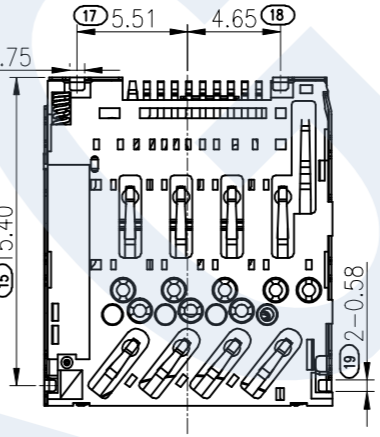
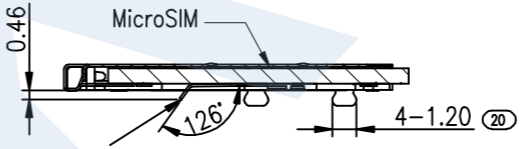
RoHS

REV.	EC#	DESCRIPTION	DATE	DRAWING	CHECKED	APPROVED
A0		NEW RELEASE	26/01'18	SUPER	SKY	TEDDY



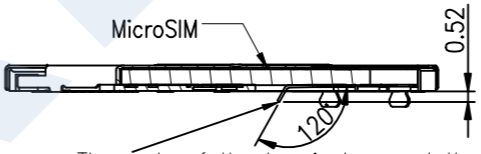






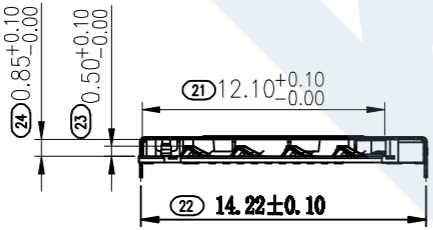
The ends of the terminals reveal the outer surface of the product

SEC A-A



The ends of the terminals reveal the outer surface of the product

SEC B-B



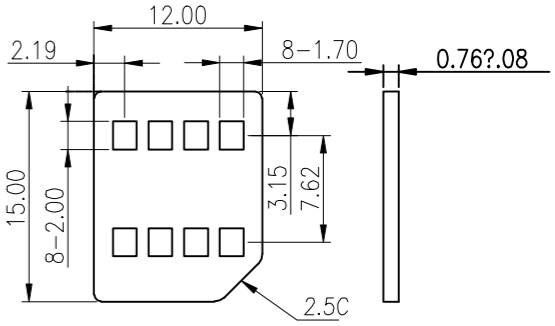
NOTES:

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.
Contact: Copper Alloy
Shell: STAINLESS
PLATING :
TERMINAL:
CONTACT AREA: GOLD OR NICKEL.
SOLDER AREA: MATTE TIN 80U" PLATED.
SHELL: GOLD OR NICKEL.
SOLDER AREA: GOLD PLATED.

Electrical:

Current Rating :1A max.
Voltage Rating :30V DC MAX
Ambient Temperature Range :-20°C~+85°C
Storage Temperature Range :-40°C~+85°C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100mΩ maxΩ
Insulation Resistance:1000M min./500V DC
Dielectric Withstanding Voltage:500V AC
Mating Cycles:5,000 Insertions
Temperature: 260°C ±5'



MICRO SIM CARD

MILLIMETERS	INCH
X.° ± 2'	X.° ± 2'
.X ±0.30	.XX ±0.012
.XX ±0.20	.XXX ±0.008
.XXX±0.10	.XXXX±0.004

UNITS MM
MAT'L SEE NOTES
FINISH SEE NOTES
QTY SEE NOTES

KKG

PART NUMBER:

TITLE: MICRO-SIM PUSH/PUSH 1.28DIP翻盖SIM卡座

APPD:

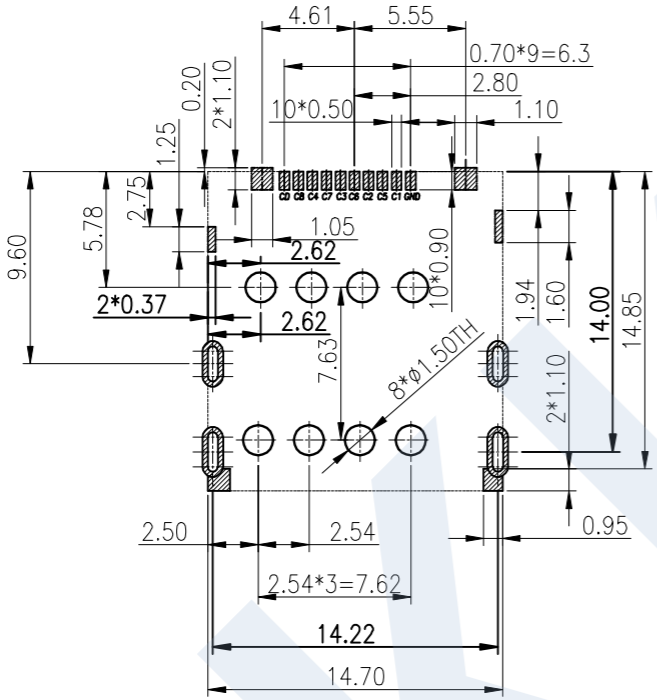
DWG NO.:

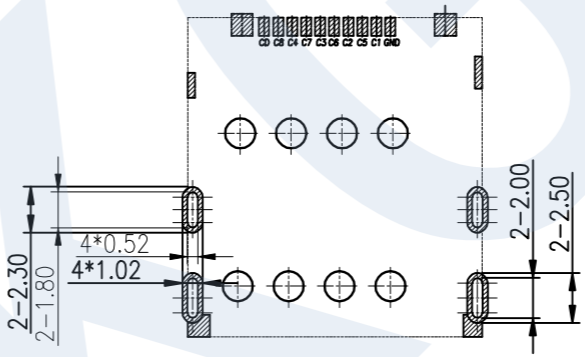
CHKD:

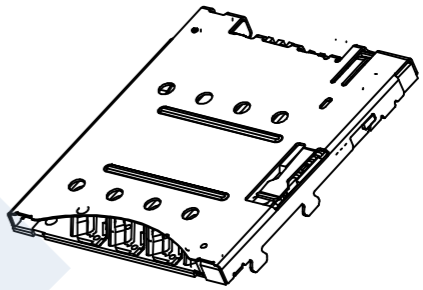
DR:

SCALE	SHEET	REV.
1:1	1/3	A0

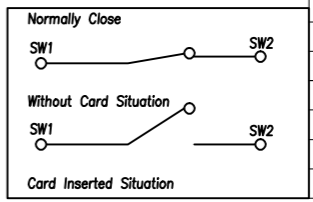
RoHS







SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved
SW1	C/D
SW2	GND



□ :NO WIRING AREA
▨ :BOARD PAD
NOTE 1: ○ :PCB through hole

Figure 5.2 RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ±0.05

NOTE 1:
After inserting the card, the terminal head will reveal the outer surface of the product, and the PCB will need to be opened to avoid the terminal.

MILLIMETERS	INCH
X.° ± 2°	X.° ± 2°
.X ±0.30	.XX ±0.012
.XX ±0.20	.XXX ±0.008
.XXX± 0.10	.XXXX± 0.004

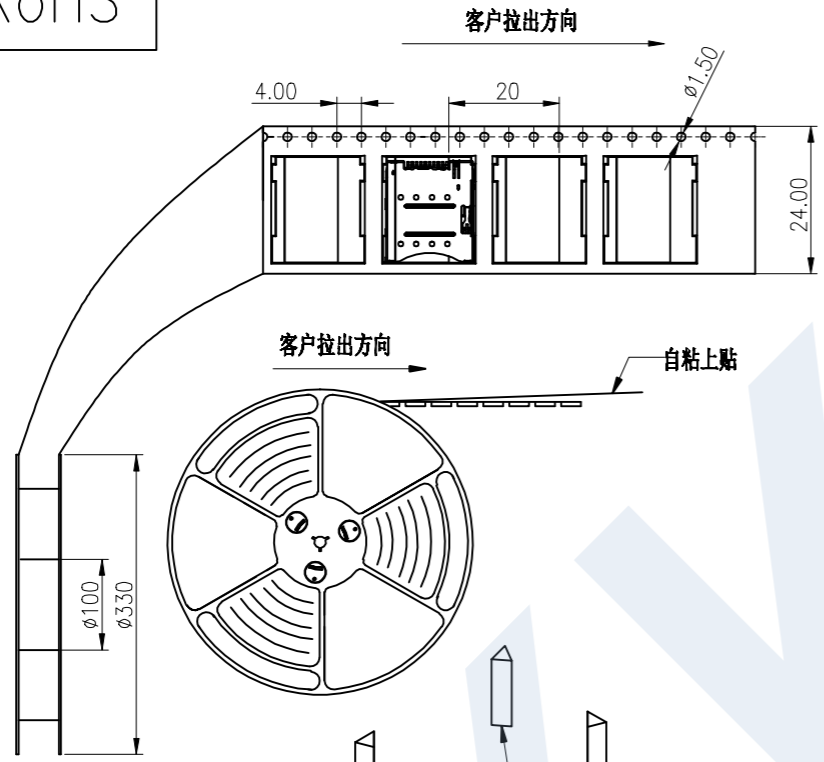
UNITS	MM
MAT'L	SEE NOTES
FINISH	SEE NOTES
QTY	SEE NOTES

KKG

PART NUMBER:	TITLE: MICRO-SIM PUSH/PUSH 1.22DIP型防盗PIN卡座
APPD:	DWG NO.:
CHKD:	
DR:	

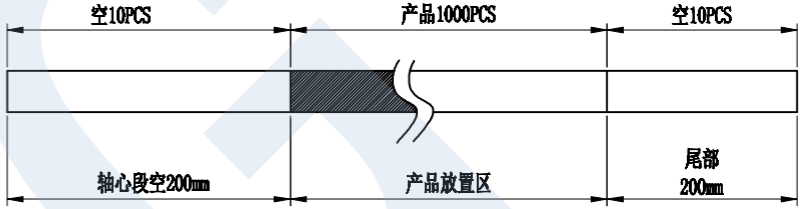
SCALE	SHEET	REV.
1:1	2/3	A0

RoHS

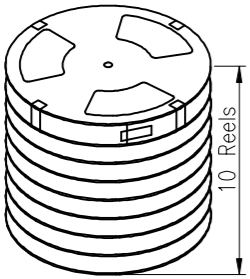


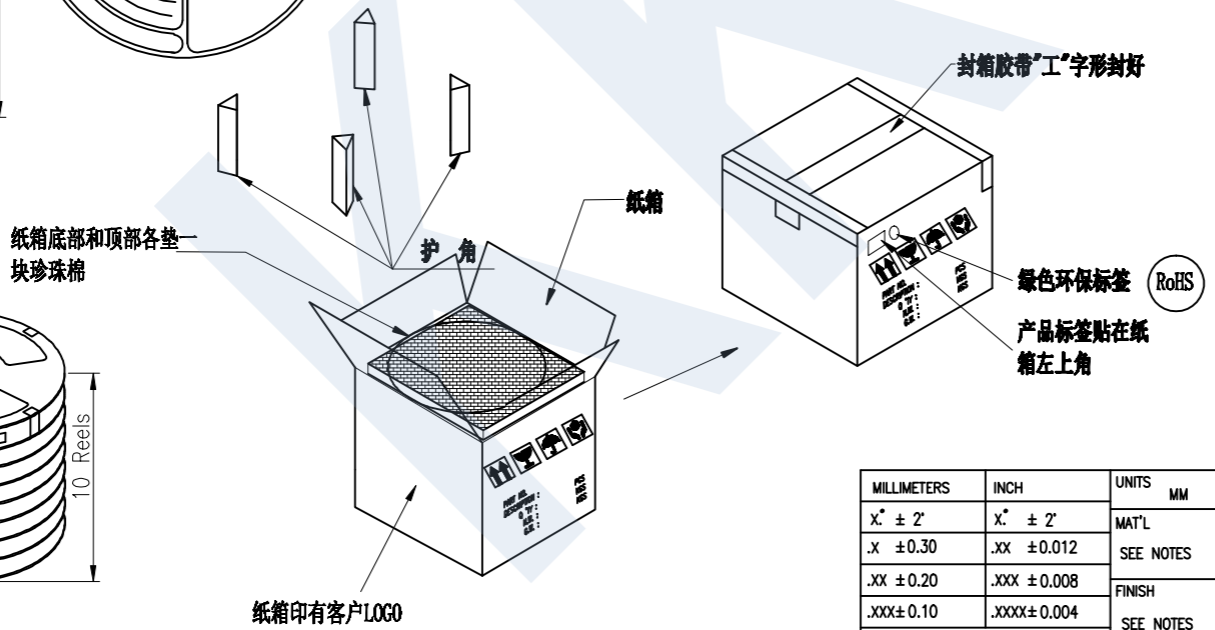
NOTES

1. 每卷包装数量:1000PCS/每卷
2. 卷带包装方式:



3. 每箱包装数量:10000PCS/箱
4. 纸箱350mm*350mm*340mm(内部尺寸),材质K=K





将10卷产品放入箱内

MILLIMETERS	INCH
X.° ± 2°	X.° ± 2°
.X ±0.30	.XX ±0.012
.XX ±0.20	.XXX ±0.008
.XXX± 0.10	.XXXX± 0.004

UNITS	MM
MAT'L	SEE NOTES
FINISH	SEE NOTES
QTY	SEE NOTES

KKG

PART NUMBER:	TITLE: MICRO-SIM PUSH/PUSH 1.28DIP型卷装PIN卡座
APPD:	DWG NO.:
CHKD:	
DR:	

SCALE	SHEET	REV.
1:1	3/3	A0